

Global SiC Wafer Thinning Equipment Market Growth 2026-2032

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Abstracts

The global SiC Wafer Thinning Equipment market size is predicted to grow from US\$ 127 million in 2025 to US\$ 214 million in 2032; it is expected to grow at a CAGR of 9.2% from 2026 to 2032.

Wafer Grinder uses a centrally located robot to move a wafer from an input station to a measuring station. Thereafter, the wafer is moved into a grind station and a wash station sequentially. The robot is able to move a wafer from the wash station to either the measuring station for after-grinding measurements or directly to an output station. During grinding of one wafer, a second wafer may be held between the measuring station and the grind station while a ground wafer is moved from the wash station to the measuring station for after-grinding measurements.

This report only studies Silicon Carbide Wafer Thinning Equipment.

In 2025, global SiC Wafer Thinning Equipment production reached approximately 254 units, with an average global market price of around US\$ 513 k per unit.

The upstream inputs for SiC wafer thinning equipment consist primarily of functional components and structural materials. Critical components include control systems, motion controllers, power electronics and precision sensors, while structural materials mainly comprise steel and enclosure materials used in machine frames and housings. Core suppliers in these categories include Siemens and Rockwell Automation for automation and control hardware, as well as Shagang Group and BASF for metallic and chemical raw materials used in machine construction and processing subsystems.

SiC wafer thinning equipment is deployed across production lines for both 6-inch-and-

below and 8-inch-and-above wafer formats, reflecting the industry's transition toward larger substrates in power semiconductor manufacturing. Typical end users include leading global SiC wafer and device manufacturers such as Wolfspeed and Coherent, etc.

Because SiC wafer thinning equipment involves high mechanical rigidity, advanced motion control, proprietary process know-how and strong customer customization, the segment typically commands relatively high profitability. Industry-wide gross margins are generally in the range of 45–60%.

The global market for SiC Wafer Thinning Equipment is expanding rapidly as silicon carbide becomes the substrate of choice for next-generation power semiconductors used in electric vehicles, renewable energy systems and industrial power electronics. From a product-type perspective, the market is clearly dominated by fully-automatic systems, which integrate robotic wafer handling, inline metrology, grinding and cleaning modules and factory automation interfaces in order to meet the strict productivity and yield requirements of high-volume fabs. Fully-automatic tools are expected to account for approximately 78% of global market revenue in 2025, reflecting customers' preference for higher throughput, lower labor dependence and tighter process control, while semi-automatic systems continue to serve pilot lines and small-batch production environments but represent a smaller and gradually declining portion of overall demand.

From the application standpoint, SiC wafer thinning equipment is deployed across both 6-inch-and-below and 8-inch-and-above wafer formats, mirroring the industry's transition toward larger substrates. Nevertheless, 6-inch-and-below lines remain the dominant application segment, representing about 69% of global market demand in 2025, as the majority of current SiC device capacity is still concentrated in legacy 150-millimeter platforms and their associated back-end process flows. At the same time, investments in 8-inch fabs are accelerating and are expected to reshape the demand mix over the medium term, creating new opportunities for advanced thinning systems capable of handling larger, thinner and more fragile wafers with high yield.

Market growth is being driven by the rapid penetration of electric vehicles, charging infrastructure and renewable-energy inverters, all of which rely heavily on SiC power devices to achieve higher efficiency and power density. Continued government support for energy transition and domestic semiconductor supply chains, together with rising capital expenditure by integrated device manufacturers and wafer suppliers, is stimulating sustained equipment purchases. Technological trends such as thinner substrates for advanced packaging, higher power module integration and tighter thermal-

management requirements are further increasing the performance specifications for thinning tools, favoring suppliers able to deliver highly automated and process-optimized platforms.

Despite these favorable dynamics, the market also faces several restraining factors. The capital-intensive nature of SiC fabs makes equipment spending sensitive to cyclical downturns in the automotive and industrial sectors, potentially leading to temporary order delays. Long qualification cycles and strict reliability standards imposed by power-electronics customers can slow the adoption of new equipment platforms, while intensified competition among tool vendors may exert pricing pressure in certain regions. In addition, the technical challenges associated with grinding extremely hard SiC substrates to ultra-thin thicknesses without inducing subsurface damage continue to require heavy investment in research and service capabilities, raising operating costs and limiting rapid capacity expansion for some suppliers.

LP Information, Inc. (LPI) ' newest research report, the “SiC Wafer Thinning Equipment Industry Forecast” looks at past sales and reviews total world SiC Wafer Thinning Equipment sales in 2025, providing a comprehensive analysis by region and market sector of projected SiC Wafer Thinning Equipment sales for 2026 through 2032. With SiC Wafer Thinning Equipment sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world SiC Wafer Thinning Equipment industry.

This Insight Report provides a comprehensive analysis of the global SiC Wafer Thinning Equipment landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading global companies with a focus on SiC Wafer Thinning Equipment portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global SiC Wafer Thinning Equipment market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for SiC Wafer Thinning Equipment and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global SiC Wafer Thinning Equipment.

This report presents a comprehensive overview, market shares, and growth opportunities of SiC Wafer Thinning Equipment market by product type, application, key manufacturers and key regions and countries.

Segmentation by Type:

Full-Automatic

Semi-Automatic

Segmentation by Number of Spindles:

Single Spindle

Dual Spindle

Segmentation by Number of Workstations:

Single-Station

Multi-Station

Segmentation by Application:

6 Inch and Below

8 Inch and Above

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

China

Japan

Korea

Southeast Asia

India

Australia

Europe

Germany

France

UK

Italy

Russia

Middle East & Africa

Egypt

South Africa

Israel

Turkey

GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analysing the company's coverage, product portfolio, its market penetration.

Disco

TSD

TOKYO SEIMITSU

Engis Corporation

Okamoto Semiconductor Equipment Division

Revasum

Koyo Machinery

G&N

Key Questions Addressed in this Report

What is the 10-year outlook for the global SiC Wafer Thinning Equipment market?

What factors are driving SiC Wafer Thinning Equipment market growth, globally and by region?

Which technologies are poised for the fastest growth by market and region?

How do SiC Wafer Thinning Equipment market opportunities vary by end market size?

How does SiC Wafer Thinning Equipment break out by Type, by Application?

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